

Data sheet acquired from Harris Semiconductor SCHS221D

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## High-Speed CMOS Logic 8-Stage Synchronous Down Counters

#### Features

- · Synchronous or Asynchronous Preset
- Cascadable in Synchronous or Ripple Mode
- Fanout (Over Temperature Range)
  - Standard Outputs................ 10 LSTTL Loads
  - Bus Driver Outputs ...... 15 LSTTL Loads
- Wide Operating Temperature Range . . . -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL}$  = 30%,  $N_{IH}$  = 30% of  $V_{CC}$  at  $V_{CC}$  = 5V
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility,
     V<sub>IL</sub>= 0.8V (Max), V<sub>IH</sub> = 2V (Min)
  - CMOS Input Compatibility, I<sub>I</sub>  $\leq$  1 $\mu$ A at V<sub>OL</sub>, V<sub>OH</sub>

### Ordering Information

| PART NUMBER     | TEMP. RANGE<br>(°C) | PACKAGE      |
|-----------------|---------------------|--------------|
| CD54HC40103F3A  | -55 to 125          | 16 Ld CERDIP |
| CD74HC40103E    | -55 to 125          | 16 Ld PDIP   |
| CD74HC40103M    | -55 to 125          | 16 Ld SOIC   |
| CD74HC40103MT   | -55 to 125          | 16 Ld SOIC   |
| CD74HC40103M96  | -55 to 125          | 16 Ld SOIC   |
| CD74HCT40103E   | -55 to 125          | 16 Ld PDIP   |
| CD74HCT40103M   | -55 to 125          | 16 Ld SOIC   |
| CD74HCT40103MT  | -55 to 125          | 16 Ld SOIC   |
| CD74HCT40103M96 | -55 to 125          | 16 Ld SOIC   |

NOTE: When ordering, use the entire part number. The suffix 96 denotes tape and reel. The suffix T denotes a small-quantity reel of 250

### Description

The 'HC40103 and CD74HCT40103 are manufactured with high speed silicon gate technology and consist of an 8-stage synchronous down counter with a single output which is active when the internal count is zero. The 40103 contains a single 8-bit binary counter. Each has control inputs for enabling or disabling the clock, for clearing the counter to its maximum count, and for presetting the counter either synchronously or asynchronously. All control inputs and the  $\overline{\text{TC}}$  output are active-low logic.

In normal operation, the counter is decremented by one count on each positive transition of the CLOCK (CP). Counting is inhibited when the  $\overline{\text{TE}}$  input is high. The  $\overline{\text{TC}}$  output goes low when the count reaches zero if the  $\overline{\text{TE}}$  input is low, and remains low for one full clock period.

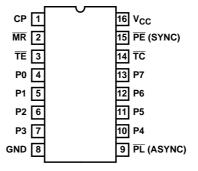
When the  $\overline{PE}$  input is low, data at the P0-P7 inputs are clocked into the counter on the next positive clock transition regardless of the state of the  $\overline{TE}$  input. When the  $\overline{PL}$  input is low, data at the P0-P7 inputs are asynchronously forced into the counter regardless of the state of the  $\overline{PE}$ ,  $\overline{TE}$ , or CLOCK inputs. Input P0-P7 represent a single 8-bit binary word for the 40103. When the MR input is low, the counter is asynchronously cleared to its maximum count of 255<sub>10</sub>, regardless of the state of any other input. The precedence relationship between control inputs is indicated in the truth table.

If all control inputs except  $\overline{\text{TE}}$  are high at the time of zero count, the counters will jump to the maximum count, giving a counting sequence of  $100_{16}$  or  $256_{10}$  clock pulses long.

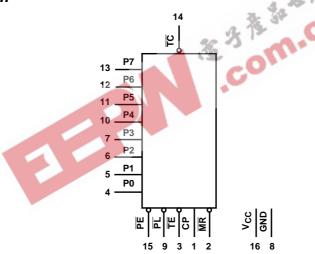
The 40103 may be cascaded using the  $\overline{\text{TE}}$  input and the  $\overline{\text{TC}}$  output, in either a synchronous or ripple mode. These circuits possess the low power consumption usually associated with CMOS circuitry, yet have speeds comparable to low power Schottky TTL circuits and can drive up to 10 LSTTL loads.

### **Pinout**

CD54HC40103 (CERDIP) CD74HC40103, CD74HCT40103 (PDIP, SOIC) TOP VIEW



### Functional Diagram



### TRUTH TABLE

|    | CONTRO | L INPUTS |    |                |  |  |  |  |  |  |
|----|--------|----------|----|----------------|--|--|--|--|--|--|
| MR | PL     | PE       | TE | PRESET MODE    | ACTION                                   |  |  |  |  |  |
| 1  | 1      | 1        | 1  | Synchronous    | Inhibit Counter                          |  |  |  |  |  |
| 1  | 1      | 1        | 0  |                | Count Down                               |  |  |  |  |  |
| 1  | 1      | 0        | Х  |                | Preset On Next Positive Clock Transition |  |  |  |  |  |
| 1  | 0      | Х        | Х  | Asynchronously | Preset Asychronously                     |  |  |  |  |  |
| 0  | Х      | Х        | Х  |                | Clear to Maximum Count                   |  |  |  |  |  |

<sup>1 =</sup> High Level.

Clock connected to clock input.

Synchronous Operation: changes occur on negative-to-positive clock transitions.

Load Inputs: MSB = P7, LSB = P0.

<sup>0 =</sup> Low Level.

X = Don't Care.

#### **Absolute Maximum Ratings Thermal Information** DC Supply Voltage, VCC $\,$ -0.5V to 7V $\,$ $\theta_{JA}$ (°C/W) Thermal Resistance (Typical, Note 1) DC Input Diode Current, I<sub>IK</sub> M (SOIC) Package..... DC Output Diode Current, IOK For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ ......±20mA Maximum Storage Temperature Range .....-65°C to 150°C DC Output Source or Sink Current per Output Pin, IO Maximum Lead Temperature (Soldering 10s).....300°C For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ ......±25mA (SOIC - Lead Tips Only) **Operating Conditions** Temperature Range, T<sub>A</sub> . . . . . . . . . . . -55°C to 125°C Supply Voltage Range, V<sub>CC</sub> DC Input or Output Voltage, $V_{\mbox{\scriptsize I}},\,V_{\mbox{\scriptsize O}}$ Input Rise and Fall Time

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

The package thermal impedance is calculated in accordance with JESD 51-7.

 DC Electrical Specifications

### **DC Electrical Specifications**

|                             |                 | TES<br>CONDIT                      |                     | vcc |      | 25°C |      | -40°C TO 85°C |      | -55°C TO 125°C |      |       |
|-----------------------------|-----------------|------------------------------------|---------------------|-----|------|------|------|---------------|------|----------------|------|-------|
| PARAMETER                   | SYMBOL          | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) | (V) | MiN  | TYP  | MAX  | MIN           | MAX  | MIN            | MAX  | UNITS |
| HC TYPES                    |                 |                                    |                     |     |      |      |      |               |      |                |      |       |
| High Level Input            | VIH             | A-                                 |                     | 2   | 1.5  | -    | -    | 1.5           | -    | 1.5            | -    | V     |
| Voltage                     |                 |                                    |                     | 4.5 | 3.15 | -    | -    | 3.15          | -    | 3.15           | -    | V     |
|                             |                 |                                    |                     | 6   | 4.2  | -    | -    | 4.2           | -    | 4.2            | -    | V     |
| Low Level Input             | V <sub>IL</sub> | -                                  | -                   | 2   | -    | -    | 0.5  | -             | 0.5  | -              | 0.5  | V     |
| Voltage                     |                 |                                    |                     | 4.5 | -    | -    | 1.35 | -             | 1.35 | -              | 1.35 | V     |
|                             |                 |                                    |                     | 6   | -    | -    | 1.8  | -             | 1.8  | -              | 1.8  | V     |
| High Level Output           | V <sub>OH</sub> | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 2   | 1.9  | -    | -    | 1.9           | -    | 1.9            | -    | V     |
| Voltage<br>CMOS Loads       |                 |                                    | -0.02               | 4.5 | 4.4  | -    | -    | 4.4           | -    | 4.4            | -    | V     |
| 5 <b>55 2</b> 5445          |                 |                                    | -0.02               | 6   | 5.9  | -    | -    | 5.9           | -    | 5.9            | -    | V     |
| High Level Output           | 7               |                                    | -                   | -   | -    | -    | -    | -             | -    | -              | -    | V     |
| Voltage<br>TTL Loads        |                 |                                    | -4                  | 4.5 | 3.98 | -    | -    | 3.84          | -    | 3.7            | -    | V     |
|                             |                 |                                    | -5.2                | 6   | 5.48 | -    | -    | 5.34          | -    | 5.2            | -    | V     |
| Low Level Output            | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 2   | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |
| Voltage<br>CMOS Loads       |                 |                                    | 0.02                | 4.5 | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |
| 000 20000                   |                 |                                    | 0.02                | 6   | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |
| Low Level Output            | 1               |                                    | -                   | -   | -    | -    | -    | -             | -    | -              | -    | V     |
| Voltage<br>TTL Loads        |                 |                                    | 4                   | 4.5 | -    | -    | 0.26 | -             | 0.33 | -              | 0.4  | V     |
| 112 20000                   |                 |                                    | 5.2                 | 6   | -    | -    | 0.26 | -             | 0.33 | -              | 0.4  | V     |
| Input Leakage<br>Current    | lı              | V <sub>CC</sub> or<br>GND          | -                   | 6   | -    | -    | ±0.1 | -             | ±1   | -              | ±1   | μΑ    |
| Quiescent Device<br>Current | Icc             | V <sub>CC</sub> or<br>GND          | 0                   | 6   | -    | -    | 8    | -             | 80   | -              | 160  | μА    |

### DC Electrical Specifications (Continued)

|  |                              | TES<br>CONDI                       |                     | V <sub>CC</sub> |      | 25°C |      | -40°C T | O 85°C | -55°C T | O 125°C |       |
|--|------------------------------|------------------------------------|---------------------|-----------------|------|------|------|---------|--------|---------|---------|-------|
| PARAMETER  | SYMBOL                       | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) | )<br>(S)        | MIN  | TYP  | MAX  | MIN     | MAX    | MIN     | MAX     | UNITS |
| HCT TYPES  |                              |                                    |                     |                 | -    |      | -    |         |        |         |         |       |
| High Level Input<br>Voltage  | V <sub>IH</sub>              | -                                  | -                   | 4.5 to<br>5.5   | 2    | -    | -    | 2       | -      | 2       | -       | V     |
| Low Level Input<br>Voltage   | V <sub>IL</sub>              | -                                  | -                   | 4.5 to<br>5.5   | -    | -    | 0.8  | -       | 0.8    | -       | 0.8     | V     |
| High Level Output<br>Voltage<br>CMOS Loads                           | V <sub>ОН</sub>              | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 4.5             | 4.4  | -    | -    | 4.4     | -      | 4.4     | -       | V     |
| High Level Output<br>Voltage<br>TTL Loads                            |                              |                                    | -4                  | 4.5             | 3.98 | -    | -    | 3.84    | -      | 3.7     | -       | V     |
| Low Level Output<br>Voltage<br>CMOS Loads                            | V <sub>OL</sub>              | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 4.5             | -    | -    | 0.1  | -       | 0.1    | -       | 0.1     | V     |
| Low Level Output<br>Voltage<br>TTL Loads                             |                              |                                    | 4                   | 4.5             | -    | -    | 0.26 | 1       | 0.33   | -       | 0.4     | V     |
| Input Leakage<br>Current   | lį                           | V <sub>CC</sub> and<br>GND         | 0                   | 5.5             | -    | 水草   | ±0.1 | CI      | ±1     | -       | ±1      | μА    |
| Quiescent Device<br>Current  | l <sub>CC</sub>              | V <sub>CC</sub> or<br>GND          | 0                   | 5.5             | 13   | ~0   | 8    | _       | 80     | -       | 160     | μΑ    |
| Additional Quiescent<br>Device Current Per<br>Input Pin: 1 Unit Load | ΔI <sub>CC</sub><br>(Note 2) | V <sub>CC</sub><br>-2.1            |                     | 4.5 to<br>5.5   |      | 100  | 360  | -       | 450    | -       | 490     | μА    |

### NOTE:

### **HCT Input Loading Table**

| INPUT  | UNIT LOADS (NOTE) |
|--------|-------------------|
| P0-P7  | 0.20              |
| TE, MR | 0.40              |
| СР     | 0.60              |
| PE     | 0.80              |
| PL     | 1.35              |

NOTE: Unit Load is  $\Delta I_{CC}$  limit specified in DC Electrical Table, e.g., 360 $\mu$ A max at 25 $^{o}$ C.

### **Prerequisite for Switching Specifications**

|                |                |                     | 25°C |     | -40°C T | O 85°C | -55°C T |     |     |       |
|----------------|----------------|---------------------|------|-----|---------|--------|---------|-----|-----|-------|
| PARAMETER      | SYMBOL         | V <sub>CC</sub> (V) | MIN  | TYP | MAX     | MIN    | MAX     | MIN | MAX | UNITS |
| HC TYPES       |                |                     |      |     |         |        |         |     |     |       |
| CP Pulse Width | t <sub>W</sub> | 2                   | 165  | -   | -       | 205    | -       | 250 | -   | ns    |
|                |                | 4.5                 | 33   | -   | -       | 41     | -       | 50  | -   | ns    |
|                |                | 6                   | 28   | -   | -       | 35     | -       | 43  | -   | ns    |
| PL Pulse Width | t <sub>W</sub> | 2                   | 125  | -   | -       | 155    | -       | 190 | -   | ns    |
|                |                | 4.5                 | 25   | -   | -       | 31     | -       | 38  | -   | ns    |
|                |                | 6                   | 21   | -   | -       | 26     | -       | 32  | -   | ns    |

<sup>2.</sup> For dual-supply systems theoretical worst case ( $V_I = 2.4V$ ,  $V_{CC} = 5.5V$ ) specification is 1.8mA.

### Prerequisite for Switching Specifications (Continued)

|                            |                      |                     |     | 25°C |     | -40°C T | O 85°C    | -55°C T | O 125°C | ]     |
|----------------------------|----------------------|---------------------|-----|------|-----|---------|-----------|---------|---------|-------|
| PARAMETER                  | SYMBOL               | V <sub>CC</sub> (V) | MIN | TYP  | MAX | MIN     | MAX       | MIN     | MAX     | UNITS |
| MR Pulse Width             | t <sub>W</sub>       | 2                   | 125 | -    | -   | 135     | -         | 190     | -       | ns    |
|                            |                      | 4.5                 | 25  | -    | -   | 31      | -         | 38      | -       | ns    |
|                            |                      | 6                   | 21  | -    | -   | 26      | -         | 32      | -       | ns    |
| CP Max. Frequency          | f <sub>CP(MAX)</sub> | 2                   | 3   | -    | -   | 2       | -         | 2       | -       | MHz   |
| (Note 3)                   |                      | 4.5                 | 15  | -    | -   | 12      | -         | 10      | -       | MHz   |
|                            |                      | 6                   | 18  | -    | -   | 14      | -         | 12      | -       | MHz   |
| P to CP Set-up Time        | tsu                  | 2                   | 100 | -    | -   | 125     | -         | 150     | -       | ns    |
|                            |                      | 4.5                 | 20  | -    | -   | 25      | -         | 30      | -       | ns    |
|                            |                      | 6                   | 17  | -    | -   | 21      | -         | 26      | -       | ns    |
| PE to CP Set-up Time       | tsu                  | 2                   | 75  | -    | -   | 95      | -         | 110     | -       | ns    |
|                            |                      | 4.5                 | 15  | -    | -   | 19      | -         | 22      | -       | ns    |
|                            |                      | 6                   | 13  | -    | -   | 16      | <u> </u>  | 19      | -       | ns    |
| TE to CP Set-up Time       | tsu                  | 2                   | 150 | -    | -   | 190     | <u></u>   | 225     | -       | ns    |
|                            |                      | 4.5                 | 30  | -    | -   | 38      | <i>ps</i> | 45      | -       | ns    |
|                            |                      | 6                   | 26  | -    | 23  | 33      | 3/17      | 38      | -       | ns    |
| P to CP Hold Time          | t <sub>H</sub>       | 2                   | 5   |      | 8 3 | 5       | -         | 5       | -       | ns    |
|                            |                      | 4.5                 | 5   |      | 700 | 5       | -         | 5       | -       | ns    |
|                            |                      | 6                   | 5   |      |     | 5       | -         | 5       | -       | ns    |
| TE to CP Hold Time         | t <sub>H</sub>       | 2                   | 0   |      | -   | 0       | -         | 0       | -       | ns    |
|                            |                      | 4.5                 | 0   |      | -   | 0       | -         | 0       | -       | ns    |
|                            |                      | 6                   | 0   | -    | -   | 0       | -         | 0       | -       | ns    |
| MR to CP Removal Time      | t <sub>REM</sub>     | 2                   | 50  | -    | -   | 65      | -         | 75      | -       | ns    |
|                            |                      | 4.5                 | 10  | -    | -   | 13      | -         | 15      | -       | ns    |
|                            |                      | 6                   | 9   | -    | -   | 11      | -         | 13      | -       | ns    |
| PE to CP Hold Time         | t <sub>H</sub>       | 2                   | 2   | -    | -   | 2       | -         | 2       | -       | ns    |
|                            |                      | 4.5                 | 2   | -    | -   | 2       | -         | 2       | -       | ns    |
|                            |                      | 6                   | 2   | -    | -   | 2       | -         | 2       | -       | ns    |
| HCT TYPES                  |                      |                     |     |      | ı   |         |           |         |         | !     |
| CP Pulse Width             | t <sub>W</sub>       | 4.5                 | 35  | -    | -   | 44      | -         | 53      | -       | ns    |
| PL Pulse Width             | t <sub>W</sub>       | 4.5                 | 43  | -    | -   | 54      | -         | 65      | -       | ns    |
| MR Pulse Width             | t <sub>W</sub>       | 4.5                 | 35  | -    | -   | 44      | -         | 53      | -       | ns    |
| CP Max. Frequency (Note 3) | f <sub>CP(MAX)</sub> | 4.5                 | 14  | -    | -   | 11      | -         | 9       | -       | MHz   |
| P to CP Set-up Time        | tsu                  | 4.5                 | 24  | -    | -   | 30      | -         | 36      | -       | ns    |
| PE to CP Set-up Time       | tsu                  | 4.5                 | 20  | -    | -   | 25      | -         | 30      | -       | ns    |
| TE to CP Set-up Time       | t <sub>SU</sub>      | 4.5                 | 40  | -    | -   | 50      | -         | 60      | -       | ns    |
| P to CP Hold Time          | t <sub>H</sub>       | 4.5                 | 5   | -    | -   | 5       | -         | 5       | -       | ns    |
| TE to CP Hold Time         | t <sub>H</sub>       | 4.5                 | 0   | -    | -   | 0       | -         | 0       | -       | ns    |
| MR to CP Removal Time      | t <sub>REM</sub>     | 4.5                 | 10  | -    | -   | 13      | -         | 15      | -       | ns    |
| PE to CP Hold Time         | tH                   | 4.5                 | 2   | _    | _   | 2       | -         | 2       | _       | ns    |

### Switching Specifications Input $t_{\rm p},\,t_{\rm f}$ = 6ns

|   |                                     | TEST                  | V                      |     | 25°C |     |          | °C<br>O⊺O |     | C TO<br>5°C |       |
|---|-------------------------------------|-----------------------|------------------------|-----|------|-----|----------|-----------|-----|-------------|-------|
| PARAMETER                                       | SYMBOL                              | CONDITIONS            | V <sub>CC</sub><br>(V) | MIN | TYP  | MAX | MIN      | MAX       | MIN | MAX         | UNITS |
| HC TYPES  |                                     |                       |                        |     |      |     |          |           |     |             |       |
| Propagation Delay                               | t <sub>PLH</sub> ,                  | $C_L = 50pF$          | 2                      | -   | -    | 300 | -        | 375       | -   | 450         | ns    |
| CP to any $\overline{\text{TC}}$ (Async Preset) | t <sub>PHL</sub>                    | C <sub>L</sub> = 50pF | 4.5                    | -   | -    | 60  | -        | 75        | -   | 90          | ns    |
|   |                                     | C <sub>L</sub> = 15pF | 5                      | -   | 25   | -   | -        |           | -   |             | ns    |
|   |                                     | C <sub>L</sub> = 50pF | 6                      | -   | -    | 51  | -        | 64        | -   | 77          | ns    |
| CP to TC (Sync Preset)                          | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 2                      | -   | -    | 300 | -        | 375       | -   | 450         | ns    |
|   | t <sub>PHL</sub>                    | C <sub>L</sub> = 50pF | 4.5                    | -   | -    | 60  | -        | 75        | -   | 90          | ns    |
|   |                                     | C <sub>L</sub> = 15pF | 5                      | -   | 25   | -   | -        | -         | -   | -           | ns    |
|   |                                     | C <sub>L</sub> = 50pF | 6                      | -   | -    | 51  | -        | 64        | -   | 77          | ns    |
| TE to TC  | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 2                      | -   | -    | 200 | -        | 250       | -   | 300         | ns    |
|   | t <sub>PHL</sub>                    | C <sub>L</sub> = 50pF | 4.5                    | -   | -    | 40  | -        | 50        | -   | 60          | ns    |
|   |                                     | C <sub>L</sub> = 15pF | 5                      | -   | 17   | -32 | 5        | -         | -   | -           | ns    |
|   |                                     | C <sub>L</sub> = 50pF | 6                      | -   | 25 3 | 34  | -        | 43        | -   | 51          | ns    |
| PL to TC  | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 2                      | 3   | 13   | 275 | 7        | 345       | -   | 415         | ns    |
|   | t <sub>PHL</sub>                    | C <sub>L</sub> = 50pF | 4.5                    | 1   |      | 55  | -        | 69        | -   | 83          | ns    |
|   |                                     | C <sub>L</sub> = 15pF | 5                      | - 0 | 23   | -   | -        | -         | -   | -           | ns    |
|   |                                     | C <sub>L</sub> = 50pF | 6                      | -   | -    | 47  | -        | 59        | -   | 71          | ns    |
| MR to TC  | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 2                      | -   | -    | 275 | -        | 345       | -   | 415         | ns    |
|   | tPHL                                | C <sub>L</sub> = 50pF | 4.5                    | -   | -    | 55  | -        | 69        | -   | 83          | ns    |
|   |                                     | C <sub>L</sub> = 15pF | 5                      | -   | 23   | -   | -        | -         | -   | -           | ns    |
|   |                                     | C <sub>L</sub> = 50pF | 6                      | -   | _    | 47  | -        | 59        | _   | 71          | ns    |
| Output Transition Time                          | t <sub>TLH</sub> , t <sub>THL</sub> | C <sub>L</sub> = 50pF | 2                      | -   | -    | 75  | -        | 95        | -   | 110         | ns    |
|   |                                     | C <sub>L</sub> = 50pF | 4.5                    | _   | -    | 15  | -        | 19        | -   | 22          | ns    |
|   |                                     | C <sub>L</sub> = 50pF | 6                      | _   | -    | 13  | -        | 16        | -   | 19          | ns    |
| Input Capacitance                               | C <sub>I</sub>                      | C <sub>L</sub> = 50pF | -                      | -   | -    | 10  | -        | 10        | -   | 10          | pF    |
| CP Maximum Frequency                            | f <sub>MAX</sub>                    | C <sub>L</sub> = 15pF | 5                      | -   | 25   | _   | -        | -         | -   | -           | MHz   |
| Power Dissipation Capacitance (Notes 4, 5)      | C <sub>PD</sub>                     | -                     | 5                      | -   | 25   | -   | -        | -         | -   | -           | pF    |
| HCT TYPES                                       | ļ.                                  |                       |                        |     |      |     | <u> </u> |           |     |             |       |
| Propagation Delay                               |                                     |                       |                        |     |      |     |          |           |     |             |       |
| CP to $\overline{\text{TC}}$ (Async Preset)     | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 4.5                    | -   | -    | 60  | -        | 75        | -   | 90          | ns    |
|   | t <sub>PHL</sub>                    | C <sub>L</sub> = 15pF | 5                      | -   | 25   | -   | -        | -         | -   | -           | ns    |
| CE to TC (Sync Preset)                          | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 4.5                    | -   | -    | 63  | -        | 79        | -   | 95          | ns    |
|   | t <sub>PHL</sub>                    | C <sub>L</sub> = 15pF | 5                      | -   | 26   | -   | -        | -         | -   | -           | ns    |
| TE to TC  | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 4.5                    | -   |      | 50  | -        | 63        | ı   | 75          | ns    |
|   | t <sub>PHL</sub>                    | C <sub>L</sub> = 15pF | 5                      | -   | 21   | -   | -        | -         | ı   | -           | ns    |
| PL to TC  | t <sub>PLH</sub> ,                  | C <sub>L</sub> = 50pF | 4.5                    | -   | -    | 68  | -        | 85        | -   | 102         | ns    |
|   | t <sub>PHL</sub>                    | C <sub>L</sub> = 15pF | 5                      | -   | 28   | -   | -        | -         | -   | -           | ns    |

### Switching Specifications Input $t_p$ , $t_f$ = 6ns (Continued)

|  | TEST                                |                       | V <sub>CC</sub> 25°C |     |     |     | -40°C TO<br>85°C |     | -55°C TO<br>125°C |     |       |
|--|-------------------------------------|-----------------------|----------------------|-----|-----|-----|------------------|-----|-------------------|-----|-------|
| PARAMETER                                  | SYMBOL                              | CONDITIONS            | (V)                  | MIN | TYP | MAX | MIN              | MAX | MIN               | MAX | UNITS |
| MR to TC                                   | <sup>t</sup> PLH,                   | C <sub>L</sub> = 50pF | 4.5                  | -   | -   | 55  | -                | 69  | -                 | 83  | ns    |
|  | t <sub>PHL</sub>                    | C <sub>L</sub> = 15pF | 5                    | -   | 23  | -   | -                | -   | -                 | -   | ns    |
| Output Transition Time                     | t <sub>THL</sub> , t <sub>TLH</sub> | C <sub>L</sub> = 50pF | 4.5                  | -   | -   | 15  | -                | 19  | -                 | 22  | ns    |
| Input Capacitance                          | C <sub>IN</sub>                     | C <sub>L</sub> = 50pF | -                    | -   | -   | 10  | -                | 10  | -                 | 10  | pF    |
| CP Maximum Frequency                       | f <sub>MAX</sub>                    | C <sub>L</sub> = 15pF | 5                    | -   | 25  | -   | -                | -   | -                 | -   | MHz   |
| Power Dissipation Capacitance (Notes 4, 5) | C <sub>PD</sub>                     | -                     | 5                    | -   | 27  | -   | -                | -   | -                 | -   | pF    |

#### NOTES:

 Noncascaded operation only. With cascaded counters clock-to-terminal count propagation delays, count enables (PE or TE)-to-clock SET UP TIMES, and count enables (PE or TE)-to-clock HOLD TIMES determine maximum clock frequency. For example, with these HC devices:

$$C_{P} \text{ f}_{MAX} = \frac{1}{\text{CP-to-}\overline{\text{TC}} \text{ prop delay} + \overline{\text{TE}}\text{-to-}\text{CP Setup Time} + \overline{\text{TE}}\text{-to-}\text{CP Hold Time}} = \frac{1}{60 + 30 + 0} \approx 11 \text{ MHz}$$

- 4. C<sub>PD</sub> is used to determine the dynamic power consumption, per package.
- 5.  $P_D = V_{CC}^2 f_i + C_L V_{CC}^2 f_0$  where  $f_i$  = Input Frequency,  $C_L$  = Output Load Capacitance,  $V_{CC}$  = Supply Voltage,  $f_0$  = Output Frequency.

### **Timing Diagrams**

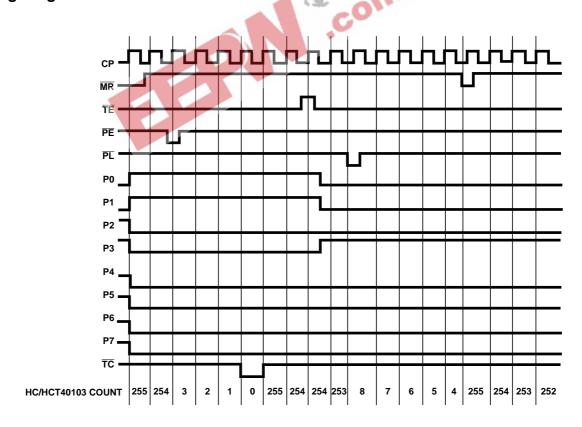


FIGURE 1.

### Test Circuits and Waveforms

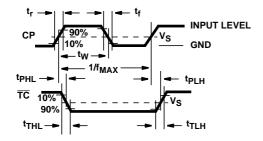


FIGURE 2.

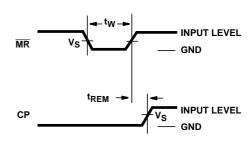


FIGURE 3.

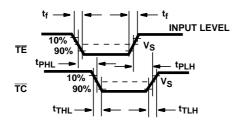


FIGURE 4.

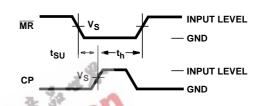


FIGURE 5.

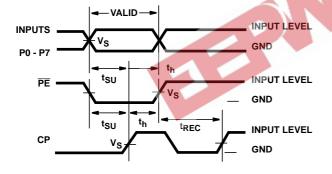


FIGURE 6.

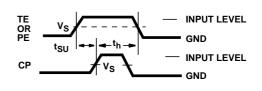
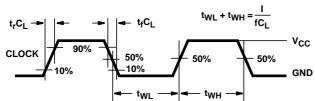


FIGURE 7.

\_ t<sub>f</sub>C<sub>L</sub> = 6ns



NOTE: Outputs should be switching from 10%  $\rm V_{CC}$  to 90%  $\rm V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

CLOCK 1.3V 0.3V GND

NOTE: Outputs should be switching from 10%  $V_{\mbox{\footnotesize{CC}}}$  to 90%  $V_{\mbox{\footnotesize{CC}}}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

FIGURE 9. HCT CLOCK PULSE RISE AND FALL TIMES AND **PULSE WIDTH** 

FIGURE 8. HC CLOCK PULSE RISE AND FALL TIMES AND **PULSE WIDTH** 

 $t_rC_L = 6ns$ 





9-Oct-2007

### **PACKAGING INFORMATION**

| Orderable Device  | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 5962-9055301EA    | ACTIVE                | CDIP            | J                  | 16   | 1              | TBD                       | A42 SNPB         | N / A for Pkg Type           |
| 5HC40103F3AS228   | OBSOLETE              | CDIP            | J                  | 16   |                | TBD                       | Call TI          | Call TI                      |
| CD54HC40103F      | ACTIVE                | CDIP            | J                  | 16   | 1              | TBD                       | A42 SNPB         | N / A for Pkg Type           |
| CD54HC40103F3A    | ACTIVE                | CDIP            | J                  | 16   | 1              | TBD                       | A42 SNPB         | N / A for Pkg Type           |
| CD74HC40103E      | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | N / A for Pkg Type           |
| CD74HC40103EE4    | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | N / A for Pkg Type           |
| CD74HC40103M      | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103M96    | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103M96E4  | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103M96G4  | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103ME4    | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103MG4    | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103MT     | ACTIVE                | SOIC            | D                  | 16   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103MTE4   | ACTIVE                | SOIC            | D                  | 16   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HC40103MTG4   | ACTIVE                | SOIC            | D                  | 16   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103E     | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | N / A for Pkg Type           |
| CD74HCT40103EE4   | ACTIVE                | PDIP            | N                  | 16   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | N / A for Pkg Type           |
| CD74HCT40103M     | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103M96   | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103M96E4 | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103M96G4 | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103ME4   | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103MG4   | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103MT    | ACTIVE                | SOIC            | D                  | 16   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103MTE4  | ACTIVE                | SOIC            | D                  | 16   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74HCT40103MTG4  | ACTIVE                | SOIC            | D                  | 16   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |



### PACKAGE OPTION ADDENDUM

9-Oct-2007

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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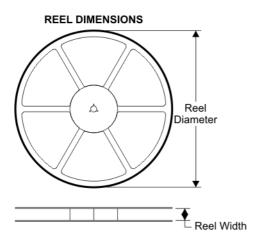
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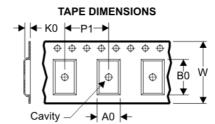


### **PACKAGE MATERIALS INFORMATION**

4-Oct-2007

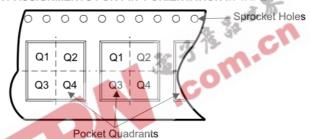
### TAPE AND REEL BOX INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
|    | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPES

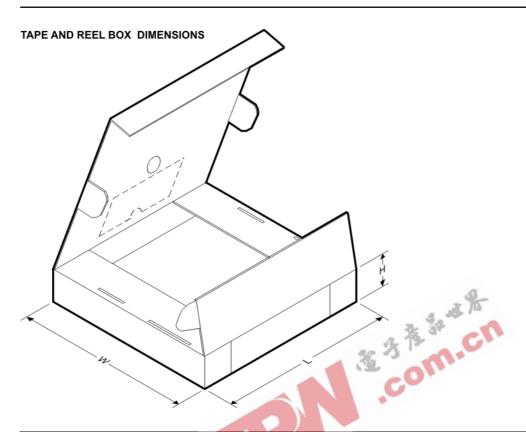


| Device          | Package | Pins |         | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|---------|------|---------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| CD74HC40103M96  | D       | 16   | SITE 27 | 330                      | 16                    | 6.5     | 10.3    | 2.1     | 8          | 16        | Q1               |
| CD74HCT40103M96 | D       | 16   | SITE 27 | 330                      | 16                    | 6.5     | 10.3    | 2.1     | 8          | 16        | Q1               |



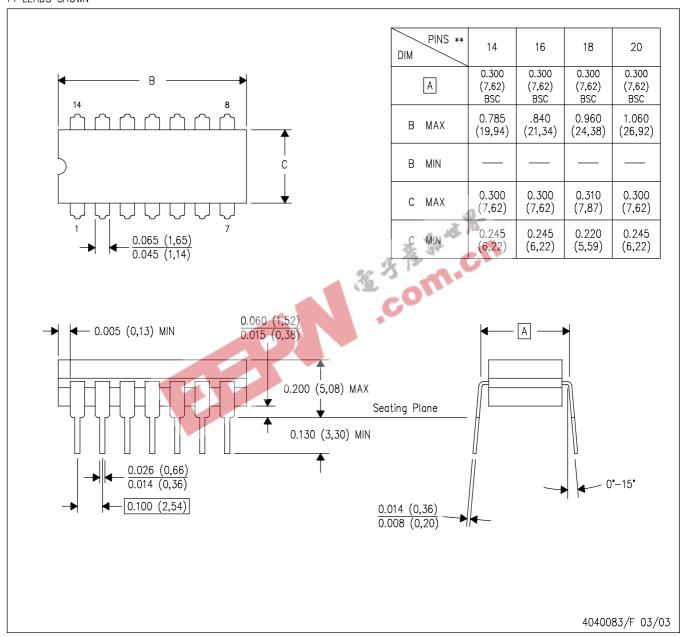


4-Oct-2007



| Device          | Package | Pins | Site    | Length (mm) | Width (mm) | Height (mm) |
|-----------------|---------|------|---------|-------------|------------|-------------|
| CD74HC40103M96  | D i     | 16   | SITE 27 | 342.9       | 336.6      | 28.58       |
| CD74HCT40103M96 | D       | 16   | SITE 27 | 342.9       | 336.6      | 28.58       |

14 LEADS SHOWN



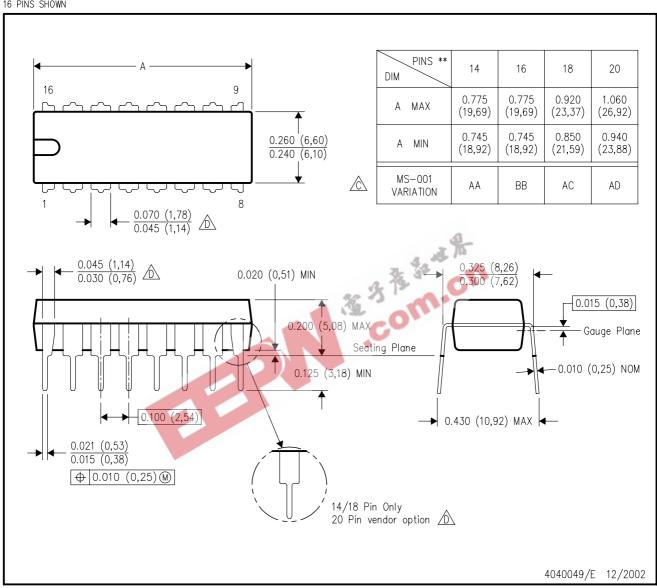
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- $E. \quad \text{Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.} \\$

## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

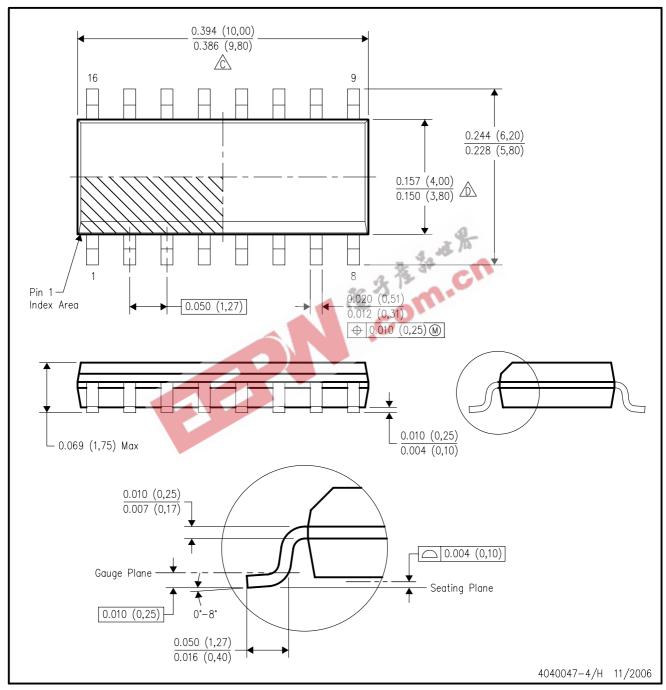


NOTES:

- All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

### D (R-PDSO-G16)

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- All linear dimensions are in inches (millimeters).
- A. All linear dimensions are in inches (millimeters).
  B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

  E. Reference JEDEC MS-012 variation AC.



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| dataconverter.ti.com   | Automotive  | www.ti.com/automotive   |
| dsp.ti.com             | Broadband   | www.ti.com/broadband  |
| interface.ti.com       | Digital Control   | www.ti.com/digitalcontrol   |
| logic.ti.com           | Military  | www.ti.com/military   |
| power.ti.com           | Optical Networking  | www.ti.com/opticalnetwork   |
| microcontroller.ti.com | Security  | www.ti.com/security   |
| www.ti-rfid.com        | Telephony   | www.ti.com/telephony  |
| www.ti.com/lpw         | Video & Imaging   | www.ti.com/video  |
|                        | Wireless  | www.ti.com/wireless   |
|                        | dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti-rfid.com | amplifier.ti.com  dataconverter.ti.com  dsp.ti.com  interface.ti.com  logic.ti.com  power.ti.com  microcontroller.ti.com  www.ti-rfid.com  www.ti.com/lpw  Automotive  Automotive  Broadband  Digital Control  Military  Optical Networking  Security  Telephony  Video & Imaging |